Rochester Electronics

Datasheet

Rochester Electronics Manufactured Components

Rochester branded components are manufactured using either die/wafers purchased from the original suppliers or Rochester wafers recreated from the original IP. All recreations are done with the approval of the OCM.

Parts are tested using original factory test programs or Rochester developed test solutions to guarantee product meets or exceed the OCM data sheet.

Quality Overview

- ISO-9001
- AS9120 certification
- Qualified Manufacturers List (QML) MIL-PRF-35835
    - Class Q Military
    - Class V Space Level
- Qualified Suppliers List of Distributors (QSLD)

    - Rochester is a critical supplier to DLA and meets all industry and DLA standards.

Rochester Electronics, LLC is committed to supplying products that satisfy customer expectations for quality and are equal to those originally supplied by industry manufacturers.

The original manufacturer's datasheet accompanying this document reflects the performance and specifications of the Rochester manufactured version of this device. Rochester Electronics guarantees the performance of its semiconductor products to the original OEM specifications. 'Typical' values are for reference purposes only. Certain minimum or maximum ratings may be based on product characterization, design, simulation, or sample testing.

FAIRCHILD SEMICONDUCTOR™

July 1988
Revised August 2000

100353
Low Power 8-Bit Register

General Description

The 100353 contains eight D-type edge triggered, master/slave flip-flops with individual inputs (D_n), true outputs (Q_n), a clock input (CP), and a common clock enable pin ($\overline{CEN}$). Data enters the master when CP is LOW and transfers to the slave when CP goes HIGH. When the $\overline{CEN}$ input goes HIGH it overrides all other inputs, disables the clock, and the Q outputs maintain the last state.

The 100353 output drivers are designed to drive 50Ω termination to −2.0V. All inputs have 50 kΩ pull-down resistors.

Features

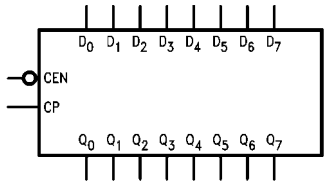
- Low power operation
- 2000V ESD protection
- Voltage compensated operating range = −4.2V to −5.7V
- Available to industrial grade temperature range

Ordering Code:

Order Number	Package Number	Package Description
100353PC	N24E	24-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-010, 0.400 Wide
100353QC	V28A	28-Lead Plastic Lead Chip Carrier (PLCC), JEDEC MO-047, 0.450 Square
100353QI	V28A	28-Lead Plastic Lead Chip Carrier (PLCC), JEDEC MO-047, 0.450 Square Industrial Temperature Range (−40°C to +85°C)

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Logic Symbol

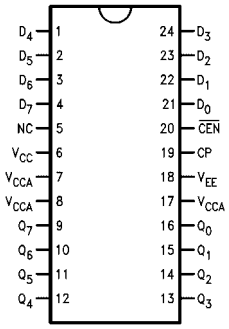


Pin Descriptions

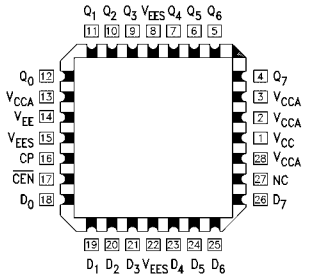
Pin Names	Description
D_0–D_7	Data Inputs
$\overline{CEN}$	Clock Enable Input
CP	Clock Input (Active Rising Edge)
Q_0–Q_7	Data Outputs
NC	No Connect

Connection Diagrams

24-Pin DIP



28-Pin PLCC

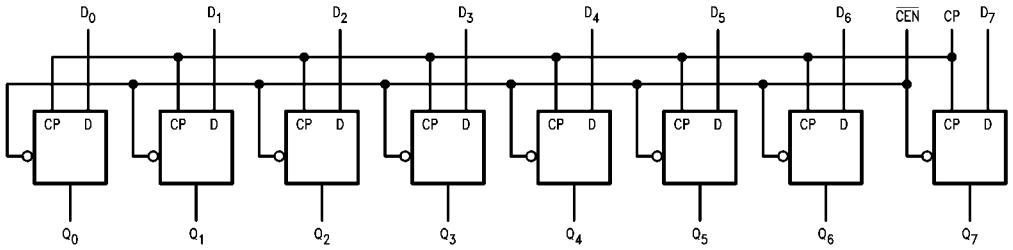


Truth Table

Inputs			Outputs
D_n	$\overline{CEN}$	CP	Q_n
L	L	↗	L
H	L	↗	H
X	X	L	NC
X	X	H	NC
X	H	X	NC

H = HIGH Voltage Level
L = LOW Voltage Level
X = Don't Care
NC = No Change
↗ = LOW-to-HIGH Transition

Logic Diagram



Absolute Maximum Ratings(Note 1)

Storage Temperature (T_{STG})	−65°C to +150°C
Maximum Junction Temperature (T_J)	+150°C
V_{EE} Pin Potential to Ground Pin	−7.0V to +0.5V
Input Voltage (DC)	V_{EE} to + 0.5V
Output Current (DC Output HIGH)	−50 mA
ESD (Note 2)	≥2000V

Recommended Operating Conditions

Case Temperature (T_C)	
Commercial	0°C to +85°C
Industrial	−40°C to +85°C
Supply Voltage (V_{EE})	−5.7V to −4.2V

Note 1: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum rating. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 2: ESD testing conforms to MIL-STD-883, Method 3015.

Commercial Version

DC Electrical Characteristics (Note 3)

V_{EE} = −4.2V to −5.7V, V_{CC} = V_{CCA} = GND, T_C = 0°C to +85°C

Symbol	Parameter	Min	Typ	Max	Units	Conditions	
V_{OH}	Output HIGH Voltage	−1025	−955	−870	mV	V_{IN} = V_{IH} (Max)	Loading with
V_{OL}	Output LOW Voltage	−1830	−1705	−1620	mV	or V_{IL} (Min)	50Ω to −2.0V
V_{OHC}	Output HIGH Voltage	−1035			mV	V_{IN} = V_{IH} (Min)	Loading with
V_{OLC}	Output LOW Voltage			−1610	mV	or V_{IL} (Max)	50Ω to −2.0V
V_{IH}	Input HIGH Voltage	−1165		−870	mV	Guaranteed HIGH Signal for all Inputs	
V_{IL}	Input LOW Voltage	−1830		−1475	mV	Guaranteed LOW Signal for all Inputs	
I_{IL}	Input LOW Current	0.50			µA	V_{IN} = V_{IL} (Min)	
I_{IH}	Input HIGH Current			240	µA	V_{IN} = V_{IH} (Max)	
I_{EE}	Power Supply Current					Inputs OPEN	
		−119		−61	mA	V_{EE} = −4.2V to −4.8V	
		−122		−61		V_{EE} = −4.2V to −5.7V	

Note 3: The specified limits represent the "worst case" value for the parameter. Since these values normally occur at the temperature extremes, additional noise immunity and guardbanding can be achieved by decreasing the allowable system operating ranges. Conditions for testing shown in the tables are chosen to guarantee operation under "worst case" conditions.

DIP AC Electrical Characteristics

V_{EE} = −4.2V to −5.7V, V_{CC} = V_{CCA} = GND

Symbol	Parameter	T_C = 0°C		T_C = +25°C		T_C = +85°C		Units	Conditions
		Min	Max	Min	Max	Min	Max		
f_{MAX}	Toggle Frequency	425		425		425		MHz	Figures 1, 2
t_{PLH} t_{PHL}	Propagation Delay CP to Output	1.40	3.00	1.40	3.00	1.50	3.10	ns	Figures 1, 2 (Note 4)
t_{TLH} t_{THL}	Transition Time 20% to 80%, 80% to 20%	0.45	2.00	0.45	2.00	0.45	2.00	ns	Figures 1, 2
t_S	Setup Time								
	D_n	1.10		1.10		1.10			
	$\overline{CEN}$ (Disable Time)	0.40		0.40		0.40		ns	Figures 1, 3
	$\overline{CEN}$ (Release Time)	1.10		1.10		1.10			
t_H	Hold Time D_n	0.10		0.10		0.10		ns	Figures 1, 4
t_{PW}(H)	Pulse Width HIGH CP	2.00		2.00		2.00		ns	Figures 1, 2

Note 4: The propagation delay specified is for single output switching. Delays may vary up to 300 ps with multiple outputs switching.

PLCC AC Electrical Characteristics

V_{EE} = –4.2V to –5.7V, V_{CC} = V_{CCA} = GND

Symbol	Parameter	T_C = 0°C		T_C = +25°C		T_C = +85°C		Units	Conditions
		Min	Max	Min	Max	Min	Max		
f_{MAX}	Toggle Frequency	425		425		425		MHz	Figures 1, 2
t_{PLH} t_{PHL}	Propagation Delay CP to Output	1.40	2.80	1.40	2.80	1.50	2.90	ns	Figures 1, 2 (Note 5)
t_{TLH} t_{THL}	Transition Time 20% to 80%, 80% to 20%	0.45	1.90	0.45	1.90	0.45	1.90	ns	Figures 1, 2
t_S	Setup Time								
	D_n	1.00		1.00		1.00			
	$\overline{CEN}$ (Disable Time)	0.30		0.30		0.30		ns	Figures 1, 3
	$\overline{CEN}$ (Release Time)	1.00		1.00		1.00			
t_H	Hold Time D_n	0		0		0		ns	Figures 1, 4
t_{PW}(H)	Pulse Width HIGH CP	2.00		2.00		2.00		ns	Figures 1, 2
t_{OSHL}	Maximum Skew Common Edge Output-to-Output Variation Data to Output Path		200		200		200	ps	PLCC Only (Note 6)
t_{OSLH}	Maximum Skew Common Edge Output-to-Output Variation Data to Output Path		200		200		200	ps	PLCC Only (Note 6)
t_{OST}	Maximum Skew Opposite Edge Output-to-Output Variation Data to Output Path		260		260		260	ps	PLCC Only (Note 6)
t_{PS}	Maximum Skew Pin (Signal) Transition Variation Data to Output Path		280		280		280	ps	PLCC Only (Note 6)

Note 5: The propagation delay specified is for single output switching. Delays may vary up to 300 ps with multiple outputs switching.

Note 6: Output-to-Output Skew is defined as the absolute value of the difference between the actual propagation delay for any outputs within the same packaged device. The specifications apply to any outputs switching in the same direction either HIGH-to-LOW (t_{OSHL}), or LOW-to-HIGH (t_{OSLH}), or in opposite directions both HL and LH (t_{OST}). Parameters t_{OST} and t_{PS} guaranteed by design.

Industrial Version

PLCC DC Electrical Characteristics

V_{EE} = −4.2V to −5.7V, V_{CC} = V_{CCA} = GND, T_C = −40°C to +85°C (Note 7)

Symbol	Parameter	T_C = −40°C		T_C = 0°C to +85°C		Units	Conditions	
		Min	Max	Min	Max			
V_{OH}	Output HIGH Voltage	−1085	−870	−1025	−870	mV	V_{IN} = V_{IH} (Max)	Loading with
V_{OL}	Output LOW Voltage	−1830	−1575	−1830	−1620	mV	or V_{IL} (Min)	50Ω to −2.0V
V_{OHC}	Output HIGH Voltage	−1095		−1035		mV	V_{IN} = V_{IH} (Min)	Loading with
V_{OLC}	Output LOW Voltage		−1565		−1610	mV	or V_{IL} (Max)	50Ω to −2.0V
V_{IH}	Input HIGH Voltage	−1170	−870	−1165	−870	mV	Guaranteed HIGH Signal for all Inputs	
V_{IL}	Input LOW Voltage	−1830	−1480	−1830	−1475	mV	Guaranteed LOW Signal for all Inputs	
I_{IL}	Input LOW Current	0.50		0.50		µA	V_{IN} = V_{IL} (Min)	
I_{IH}	Input HIGH Current		240		240	µA	V_{IN} = V_{IH} (Max)	
I_{EE}	Power Supply Current						Inputs OPEN	
		−119	−61	−119	−61	mA	V_{EE} = −4.2V to −4.8V	
		−122	−61	−122	−61		V_{EE} = −4.2V to −5.7V	

Note 7: The specified limits represent the "worst case" value for the parameter. Since these values normally occur at the temperature extremes, additional noise immunity and guardbanding can be achieved by decreasing the allowable system operating ranges. Conditions for testing shown in the tables are chosen to guarantee operation under "worst case" conditions.

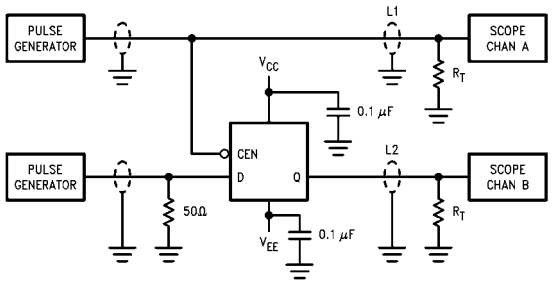
PLCC AC Electrical Characteristics

V_{EE} = −4.2V to −5.7V, V_{CC} = V_{CCA} = GND

Symbol	Parameter	T_C = −40°C		T_C = +25°C		T_C = +85°C		Units	Conditions
		Min	Max	Min	Max	Min	Max		
f_{MAX}	Toggle Frequency	425		425		425		MHz	Figures 1, 2
t_{PLH} t_{PHL}	Propagation Delay CP to Output	1.40	2.80	1.40	2.80	1.50	2.90	ns	Figures 1, 2 (Note 8)
t_{TLH} t_{THL}	Transition Time 20% to 80%, 80% to 20%	0.40	2.50	0.45	1.90	0.45	1.90	ns	Figures 1, 2
t_S	Setup Time								
	D_n	0.60		1.00		1.00			
	$\overline{CEN}$ (Disable Time)	0.90		0.30		0.30		ns	Figures 1, 3
	$\overline{CEN}$ (Release Time)	1.40		1.00		1.00			
t_H	Hold Time D_n	0.30		0		0		ns	Figures 1, 4
t_{PW}(H)	Pulse Width HIGH CP	2.00		2.00		2.00		ns	Figures 1, 2

Note 8: The propagation delay specified is for single output switching. Delays may vary up to 300 ps with multiple outputs switching.

Test Circuitry



Note:

- V_{CC}, V_{CCA} = +2V, V_{EE} = −2.5V
- L1 and L2 = equal length 50Ω impedance lines
- R_T = 50Ω terminator internal to scope
- Decoupling 0.1 µF from GND to V_{CC} and V_{EE}
- All unused outputs are loaded with 50Ω to GND
- C_L = Fixture and stray capacitance ≤ 3 pF

FIGURE 1. AC, Toggle Frequency Test Circuit

Switching Waveforms

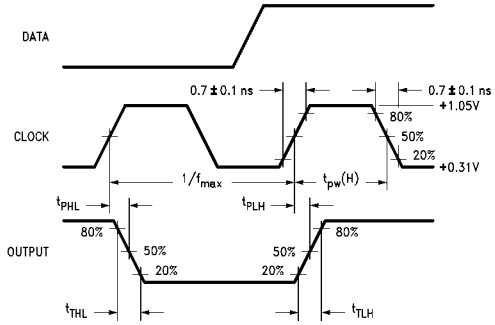


FIGURE 2. Propagation Delay (Clock) and Transition Times

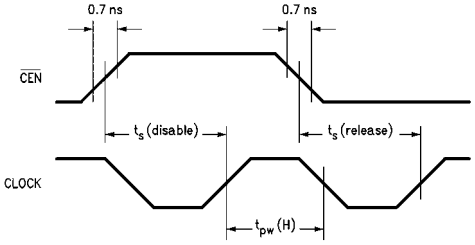
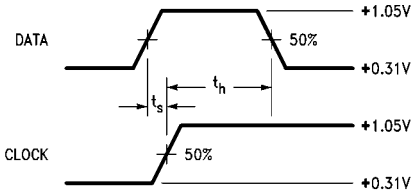


FIGURE 3. Setup and Pulse Width Times



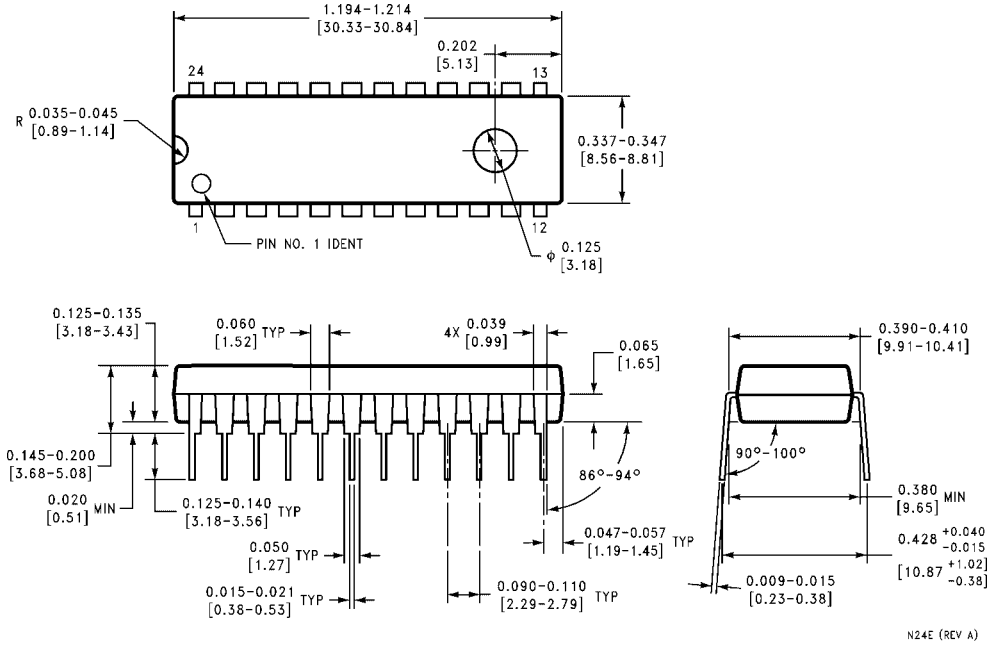
Note:

t_S is the minimum time before the transition of the clock that information must be present at the data input.

t_H is the minimum time after the transition of the clock that information must remain unchanged at the data input.

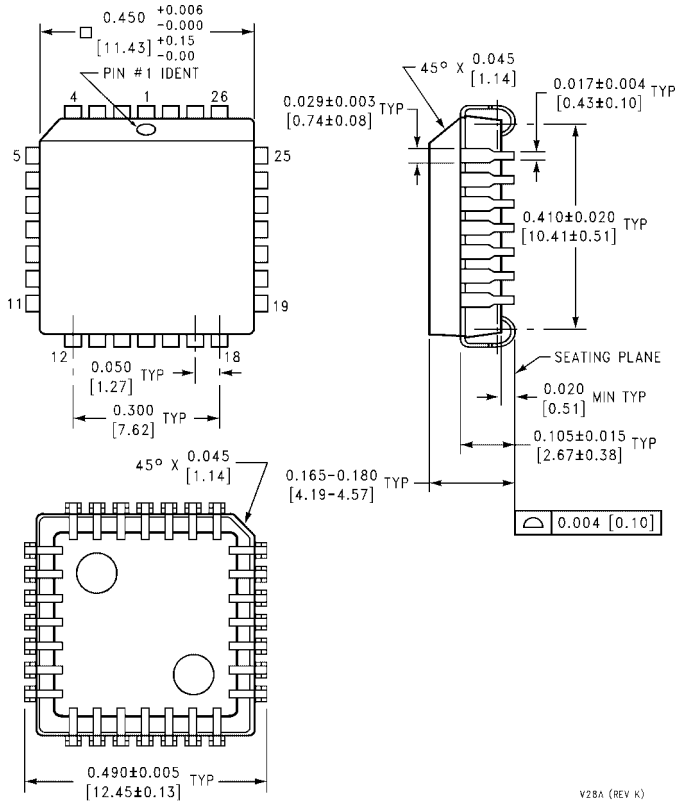
FIGURE 4. Data Setup and Hold Time

Physical Dimensions inches (millimeters) unless otherwise noted



24-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-010, 0.400 Wide
Package Number N24E

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



28-Lead Plastic Lead Chip Carrier (PLCC), JEDEC MO-047, 0.450 Square
Package Number V28A